



BOARD CHARACTERISTICS

Copper Layer Count:	2	Board Thickness:	1.6000 mm
Board overall dimensions:	120.0000 mm x 50.0000 mm		
Min track/spacing:	0.0000 mm / 0.0000 mm	Min hole diameter:	0.3000 mm
Copper Finish:	None	Impedance Control:	No
Castellated pads:	No	Plated Board Edge:	No
Edge card connectors:	No		

Daniel Anishchenko, Tyler Tran
Cuauhtemoc Gomez, Cody Reid
Portland State University

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Title: ChargeGuard Pro + (CAD)

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